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CDCLVP110

SCAS683A-JUNE 2002-REVISED AUGUST 2002

LOW-VOLTAGE 1:10 LVPECL/HSTL WITH SELECTABLE INPUT CLOCK DRIVER

FEATURES

- Distributes One Differential Clock Input Pair LVPECL/HSTL to 10 Differential LVPECL Clock Outputs
- Fully Compatible With LVECL/LVPECL/HSTL
- Single Supply Voltage Required, ±3.3-V or ±2.5-V Supply
- Selectable Clock Input Through CLK_SEL
- Low-Output Skew (Typ 15 ps) for Clock-Distribution Applications
- VBB Reference Voltage Output for Single-Ended Clocking
- Available in a 32-Pin LQFP Package
- Frequency Range From DC to 3.5 GHz
- Pin-to-Pin Compatible With MC100 Series EP111, ES6111, LVEP111, PTN1111

LQFP PACKAGE

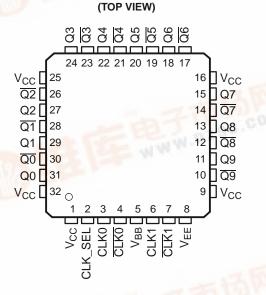
DESCRIPTION

The CDCLVP110 clock driver distributes one differential clock pair of either LVPECL or HSTL (selectable) input, (CLK0, CLK1) to ten pairs of differential LVPECL clock (Q0, Q9) outputs with minimum skew for clock distribution. The CDCLVP110 can accept two clock sources into an input multiplexer. The CLK0 input accepts either LVECL/LVPECL input signals, while CLK1 accepts an HSTL input signal when operated under LVPECL conditions. The CDCLVP110 is specifically designed for driving 50- Ω transmission lines.

The VBB reference voltage output is used if single-ended input operation is required. In this case the VBB pin should be connected to CLKO and bypassed to GND via a 10-nF capacitor.

However, for high-speed performance up to 3.5 GHz, the differential mode is strongly recommended.

The CDCLVP110 is characterized for operation from -40°C to 85°C.



FUNCTION TABLE

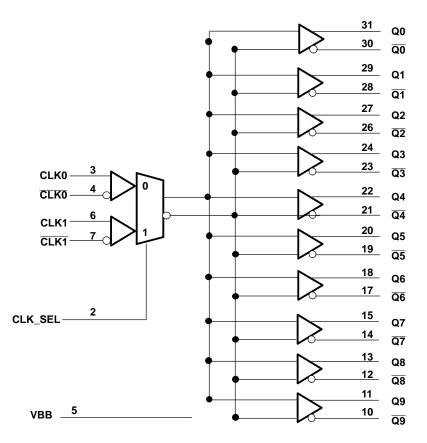
CLK_SEL	ACTIVE CLOCK INPUT
0	CLK0, CLK0
1	CLK1, CLK1

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TERMINAL FUNCTIONS

TERMINAL NAME NO.		DESCRIPTION
		DESCRIPTION
CLK_SEL	2	Clock select. Used to select between CLK0 and CLK1 input pairs.
CLK0, CLK0	3, 4	Differential LVECL/LVPECL input pair
CLK1, CLK1	6, 7	Differential HSTL input pair
Q [9:0]	11, 13, 15, 18, 20, 22, 24, 27, 29, 31	LVECL/LVPECL clock outputs, these outputs provide low-skew copies of CLKn.
<u>Q</u> [9:0]	10, 12, 14, 17, 19, 21,23, 26, 28, 30	LVECL/LVPECL complementary clock outputs, these outputs provide copies of CLKn.
V _{BB} 5 F		Reference voltage output for single-ended input operation
V _{CC} 1, 9, 16, 25, 32 Supply voltage		Supply voltage
V _{EE}	8	Device ground or negative supply voltage in ECL mode

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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Supply voltage	-0.3 V to 4.6 V	
Input voltage	-0.3 V to V _{CC} + 0.5 V	
Output voltage	-0.3 V to V _{CC} + 0.5 V	
Input current	±20 mA	
Negative supply voltage	-0.3 V to 4.6 V	
Sink/source current	-1 to 1 mA	
DC output current	-50 mA	
Storage temperature range	-65°C to 150°C	
	Input voltage Output voltage Input current Negative supply voltage Sink/source current DC output current	Input voltage -0.3 V to V _{CC} + 0.5 V Output voltage -0.3 V to V _{CC} + 0.5 V Input current ±20 mA Negative supply voltage -0.3 V to 4.6 V Sink/source current -1 to 1 mA DC output current -50 mA

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage (relative to V_{EE})	2.375	2.5/3.3	3.8	V
T _A ⁽¹⁾	Operating free-air temperature	-40		85	°C

(1) Operating junction temperature affects device lifetime. The continuous operation junction temperature is recommended to be at max 110°C. The device ac and dc parameters are specified up to 85°C ambient temperature. See the PCB Layout Guidelines for CDCLVP110 application note, literature number SCAA057 for more details.

PACKAGE THERMAL IMPEDANCE

		TEST CONDITION	MIN	MAX	UNIT
		0 LFM		78	°C/W
	Thermal resistance junction to ambient ⁽¹⁾	150 LFM		73	°C/W
Θ_{JA}		250 LFM		71	°C/W
		500 LFM		68	°C/W
Θ_{JC}	Thermal resistance junction to case			51	°C/W

(1) According to JESD 51-7 standard.

LVECL DC ELECTRICAL CHARACTERISTICS

Vsupply: $V_{CC} = 0 \text{ V}$, $V_{EE} = -2.375 \text{ V}$ to -3.8 V

	PARAMETER	TEST CONDITIONS		MIN	TYP MAX	UNIT
			-40°C	40	78	
I _{EE}	Supply internal current	nt Absolute value of current	25°C	45	82	mA
			85°C	48	85	
			-40°C		343	
I _{CC}	Output and internal supply current	All outputs terminated 50 Ω to V_{CC} - 2 V	25°C		370	mA
	ounon		85°C		380	
I _{IN}	Input current	Includes pullup/pulldown resistors	-40°C, 25°C, 85°C		150	μA
			-40°C	-1.38	-1.26	
		For V_{EE} = -3 to -3.8 V, I_{BB} = -0.2 mA	25°C	-1.42	-1.26	
V _{BB}	Internally generated bias		85°C	-1.45	-1.26	v
	voltage	V_{EE} = -2.375 to -2.75 V, I _{BB} = -0.2 mA	-40°C, 25°C, 85°C	-1.38	-1.16	
V _{IH}	High-level input voltage (CLK_SEL)		-40°C, 25°C, 85°C	-1.165	-0.88	V



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LVECL DC ELECTRICAL CHARACTERISTICS (continued)

Vsupply: V_{CC} = 0 V, V_{EE} = -2.375 V to -3.8 V

	PARAMETER	TEST CONDITIONS		MIN	TYP MAX	UNIT
V _{IL}	Low-level input voltage (CLK_SEL)		-40°C, 25°C, 85°C	-1.81	-1.475	V
VIN _{PP}	Input amplitude (CLK0, CLK0)	Difference of input 9 $V_{I\!H}\text{-}V_{I\!L}$, See Note $^{(1)}$	-40°C, 25°C, 85°C	0.5	1.3	V
V _{CM}	Common-mode voltage (CLK0, CLK0)	Cross point of input 9 average (V _{IH} , V _{IL})	-40°C, 25°C, 85°C	V _{EE} + 1	-0.3	V
			-40°C	-1.26	-0.9	
V _{OH}	High-level output voltage	I _{OH} = -21 mA	25°C	-1.2	-0.9	V
			85°C	-1.15	-0.9	
			-40°C	-1.85	-1.5	
V _{OL}	Low-level output voltage	I _{OL} = -5 mA	25°C	-1.85	-1.45	V
			85°C	-1.85	-1.4	
V _{OD}	Differential output voltage swing	Terminated with 50 Ω to V_{CC} - 2 V, See Figure 3	-40°C, 25°C, 85°C	600		V

(1) VIN_{PP} minimum and maximum is required to maintain ac specifications, actual device function tolerates a minimum VIN_{PP} of 100 mV.

LVPECL/HSTL DC ELECTRICAL CHARACTERISTICS

Vsupply: V_{CC} = 2.375 V to 3.8 V, V_{EE} = 0 V

	PARAMETER	TEST CONDITIONS		MIN	TYP MAX	UNIT
			-40°C	40	78	
I _{EE}	Supply internal current	Absolute value of current	25°C	45	82	mA
			85C	48	85	
			-40°C		343	
I _{CC}	Output and internal supply current	All outputs terminated 50 Ω to V_{CC} - 2 V	25°C		370	mA
			85°C		380	
I _{IN}	Input current	Includes pullup/pulldown resistors	ncludes pullup/pulldown resistors -40°C, 25°C, 85°C		150	μA
	Internally generated		-40°C	V _{CC} - 1.38	V _{CC} - 1.26	
		$V_{EE} = -3 \text{ to } -3.8 \text{ V}, \text{ I}_{BB} = -0.2 \text{ mA}$	25°C	V _{CC} - 1.42	V _{CC} - 1.26	
V _{BB}			85°C	V _{CC} - 1.45	V _{CC} - 1.26	V
55	bias voltage	V_{EE} = -2.375 to -2.75 V, I _{BB} = -0.2 mA	-40°C, 25°C, 85°C	V _{CC} - 1.38	V _{CC} - 1.16	
V _{IH}	High-level input voltage (CLK_SEL)	-40°C, 25°C, 85°C		V _{CC} - 1.165	V _{CC} - 0.88	V
V _{IL}	Low-level input voltage (CLK_SEL)	-40°C, 25°C, 85°C		V _{CC} - 1.81	V _{CC} - 1.475	V
VIN _{PP}	Input amplitude (CLK0, CLK0)	Difference of input 9 V_{IH} - V_{IL} , see Note ⁽¹⁾ 85°C		0.5	1.3	V
V _{IC}	Common-mode voltage (CLK0, CLK0)	Cross point of input 9 average (V_{IH} , V_{IL})	-40°C, 25°C, 85°C	1	V _{CC} - 0.3	V

LVPECL/HSTL DC ELECTRICAL CHARACTERISTICS (continued)

Vsupply: V_{CC} = 2.375 V to 3.8 V, V_{EE}= 0 V

	PARAMETER	TEST CONDITIONS		MIN	TYP MAX	UNIT
V _{ID}	Differential input voltage (CLK1, CLK1)	Difference of input V_{IH} - V_{IL} , See Note ⁽¹⁾	-40°C, 25°C, 85°C	0.4	1.9	V
V _{I(x)}	Input crossover voltage (CLK1, CLK1)	Cross point of input 9 average (V_{IH} , V_{IL})	-40°C, 25°C, 85°C	0.68	0.9	V
			-40°C	V _{CC} - 1.26	V _{CC} - 0.9	
V _{OH}	High-level output	ligh-level output bltage	25°C	V _{CC} - 1.2	V _{CC} - 0.9	V
	vonage		85°C	V _{CC} - 1.15	V _{CC} - 0.9	
			-40°C	V _{CC} - 1.85	V _{CC} - 1.5	
V _{OL}	Low-level output voltage	I _{OL} = -5 mA	25°C	V _{CC} - 1.85	V _{CC} - 1.45	V
voltage			85°C	V _{CC} - 1.85	V _{CC} - 1.4	
V _{OD}	Differential output voltage swing	Terminated with 50 Ω to V_{CC} - 2 V, See Figure 4	-40°C, 25°C, 85°C	600		mV

AC ELECTRICAL CHARACTERISTICS

Vsupply: V_{CC} = 2.375 V to 3.8 V, V_{EE} = 0 V or LVECL/LVPECL input V_{CC} = 0 V, V_{EE} = -2.375 V to -3.8 V

	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t _{pd}	Differential propagation delay CLK0, CLK0 to all Q0, Q0 Q9, Q9	Input condition: VCM = 1 V, $V_{PP} = 0.5 V$	-40°C, 25°C, 85°C	230		350	ps
t _{sk(pp)}	Part-to-part skew	See Note B and Figure 1	-40°C, 25°C, 85°C			70	ps
t _{sk(o)}	Output-to-output skew	See Note A and Figure 1	-40°C, 25°C, 85°C		15	30	ps
t _(JITTER)	Cycle-to-cycle RMS jitter		-40°C, 25°C, 85°C			< 1	ps
f _(max)	Maximum frequency	Functional up to 3.5 GHz, timing specifications apply at 1 GHz, see Figure 3	-40°C, 25°C, 85°C			3500	MHz
t _r /t _f	Output rise and fall time (20%, 80%)		-40°C, 25°C, 85°C	100		200	ps

HSTL INPUT

Vsupply: V_{CC} = 2.375 V to 3.8 V, V_{EE} = 0 V

	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t _{pd}	Differential propagation delay CLK0, CLK0 to all Q0, $\overline{\text{Q0}}$ Q9, $\overline{\text{Q9}}$	Input condition: $V_x = 0.68 V$, $V_{dif} = 0.4 V$	-40°C, 25°C, 85°C	290		370	ps
t _{sk(pp)}	Part-to-part skew	See Note B and Figure 1	-40°C, 25°C, 85°C			70	ps
t _{sk(o)}	Output to output skew	See Note A and Figure 1	-40°C, 25°C, 85°C		10	30	ps
t _(JITTER)	Cycle-to-cycle RMS jitter		-40°C, 25°C, 85°C			<1	ps

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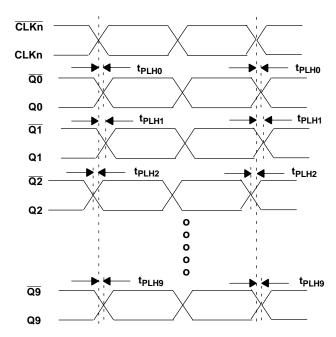
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HSTL INPUT (continued)

Vsupply: V_{CC} = 2.375 V to 3.8 V, V_{EE} = 0 V

	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
f _(max)	Maximum frequency	Functional up to 3.5 GHz, timing specifications apply at 1 GHz, See Figure 4	-40°C, 25°C, 85°C			3500	MHz
t _r /t _f	Output rise and fall time (20%, 80%)		-40°C, 25°C, 85°C	100		200	ps



- A. Output skew is calculated as the greater of: The difference between the fastest and the slowest t_{PLHn} (n = 0, 1,...9) or the difference between the fastest and the slowest t_{PHLn} (n = 0, 1,...9).
- B. Part-to-part skew, is calculated as the greater of: The difference between the fastest and the slowest t_{PLHn} (n = 0, 1,...9) across multiple devices or the difference between the fastest and the slowest t_{PHLn} (n = 0, 1,...9) across multiple devices.

Figure 1. Waveform for Calculating Both Output and Part-to-Part Skew

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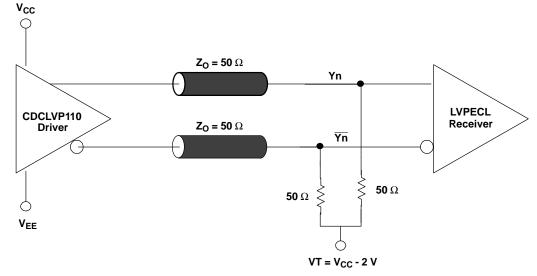
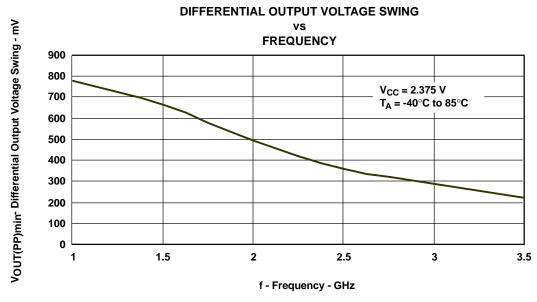


Figure 2. Typical Termination for Output Driver (See the Interfacing Between LVPECL, LVDS, and CML Application Note, Literature Number SCAA056)





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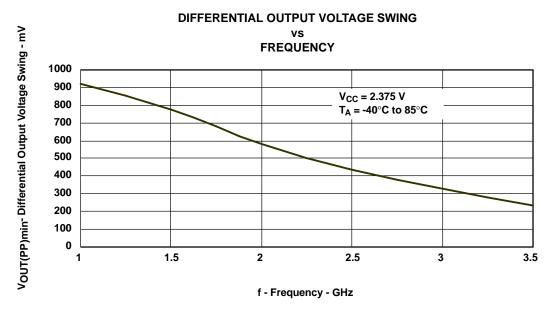


Figure 4. HSTL Input Using CLK1 Pair, VCM = 0.68 V, VIN_{dif} = 0.4 V

4-Mar-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CDCLVP110VF	ACTIVE	LQFP	VF	32	250	None	CU NIPDAU	Level-2-220C-1 YEAR
CDCLVP110VFR	ACTIVE	LQFP	VF	32	1000	None	CU NIPDAU	Level-2-220C-1 YEAR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

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⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

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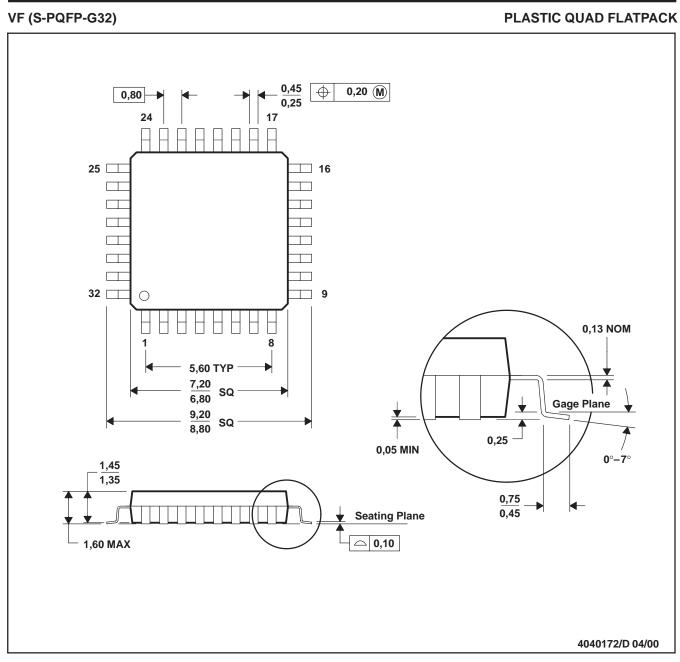
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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MECHANICAL DATA

MTQF002B - JANUARY 1995 - REVISED MAY 2000



NOTES: A. All linear dimensions are in millimeters. B. This drawing is subject to change without notice.



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